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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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## **DATA SHEET**



# BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu$ PC4082

## J-FET INPUT DUAL OPERATIONAL AMPLIFIER

#### **DESCRIPTION**

The  $\mu$ PC4082 is a dual operational amplifier incorporating well matched ion implant P-channel J-FET on the same chip with standard bipolar transistors. The key features of this op amp is very low input bias current and high slew rate for ten times faster than conventional general purpose op amps. By these features the  $\mu$ PC4082 is excellent choice for wide variety of applications including integrator, active filter, pulse amp etc.

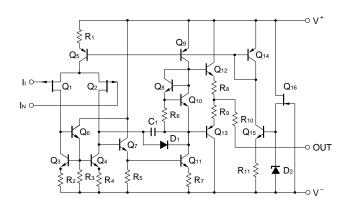
## **FEATURES**

- Low noise:  $e_n = 25 \text{ nV}/\sqrt{\text{Hz}}$  (TYP.)
- · Very low input bias and offset currents
- · Output short circuit protection
- High input impedance...J-FET Input stage
- · Internal frequency compensation
- High slew rate...13 V/μs (TYP.)

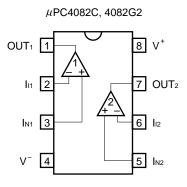
#### **ORDERING INFORMATION**

Part Number	Package	
μPC4082C	8-pin plastic DIP (7.62 mm (300))	
μPC4082G2	8-pin plastic SOP (5.72 mm (225))	

## **EQUIVALENT CIRCUIT**



#### PIN CONFIGURATION (Top View)



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## ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Pai	rameter	Symbol	Ratings	Unit
Voltage between V <sup>+</sup> a	and V <sup>-Note 1</sup>	$V^+ - V^-$	-0.3 to +36	V
Differential Input Volta	age	VID	±30	٧
Input Voltage Note 2		Vı	V <sup>-</sup> –0.3 to V <sup>+</sup> +0.3	V
Output Voltage Note 3		Vo	V <sup>-</sup> -0.3 to V <sup>+</sup> +0.3	V
Power Dissipation	C Package Note 4	Рт	350	mW
	G2 Package Note 5		440	mW
Output Short Circuit D	Ouration Note 6		Indefinite	sec
Operating Ambient Temperature		Та	-20 to +80	°C
Storage Temperature		Tstg	-55 to +125	°C

- **Notes 1.** Reverse connection of supply voltage can cause destruction.
  - 2. The input voltage should be allowed to input without damage or destruction. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The normal operation will establish when the both inputs are within the Common Mode Input Voltage Range of electrical characteristics.
  - 3. This specification is the voltage which should be allowed to supply to the output terminal from external without damage or destructive. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The output voltage of normal operation will be the Output Voltage Swing of electrical characteristics.
  - 4. Thermal derating factor is -5.0 mV/°C when operating ambient temperature is higher than 55°C.
  - 5. Thermal derating factor is -4.4 mV/°C when operating ambient temperature is higher than 25°C.
  - **6.** Pay careful attention to the total power dissipation not to exceed the absolute maximum ratings, Note 4 and Note 5.

#### RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	$V^{\pm}$	±5		±16	V
Output Current	lo			±10	mA
Capacitive Load (A <sub>V</sub> = +1, R <sub>f</sub> = 0 $\Omega$ )	CL			100	pF

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C, $V^{\pm}$ = ±15 V)

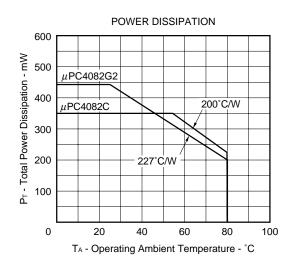
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Input Offset Voltage	Vio	$Rs \leq 50~\Omega$		±5	±15	mV
	Input Offset Current Note 7	lio			±5	±200	рА
	Input Bias Current Note 7	Ів			30	400	рА
	Large Signal Voltage Gain	Av	$R_L \geq 2~k\Omega$ , Vo = $\pm 10~V$	25000	200000		
*	Supply Current Note 8	Icc	Io = 0 A		4.0	5.6	mA
	Common Mode Rejection Ratio	CMR		70	76		dB
	Supply Voltage Rejection Ratio	SVR		70	76		dB
	Output Voltage Swing	Vom	$R_L \geq 10 \; k\Omega$	±12	±13.5		V
			$R_L \geq 2 \; k\Omega$	±10	±12		V
	Common Model Input Voltage Range	VICM		±10	+15		V
					-12.7		
	Slew Rate	SR	A <sub>V</sub> = 1		13		V/μs
	Unity Gain Frequency	funity			3		MHz
	Input Equivalent Noise Voltage Density	<b>e</b> n	Rs = 100 Ω, f = 1 kHz		25		nV/√ <del>Hz</del>
	Channel Separation				120		dB
	Input Offset Voltage	Vio	Rs $\leq$ 50 $\Omega$ , T <sub>A</sub> = -20 to +70°C			±20	mV
	Average Vio Temperature Drift	ΔVιο/ΔΤ	T <sub>A</sub> = -20 to +70°C		±10		μV/°C
	Input Offset Current Note 7	lio	T <sub>A</sub> = -20 to +70°C			±5	nA
	Input Bias Current Note 7	Ів	T <sub>A</sub> = -20 to +70°C			10	nA

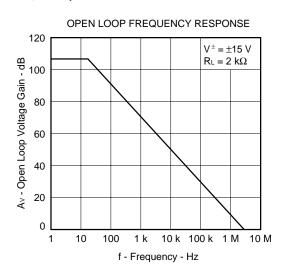
**Notes 7.** Input bias currents flow into IC. Because each currents are gate leak current of P-channel J-FET on input stage. And that are temperature sensitive. Short time measuring method is recommendable to maintain the junction temperature close to the operating ambient temperature.

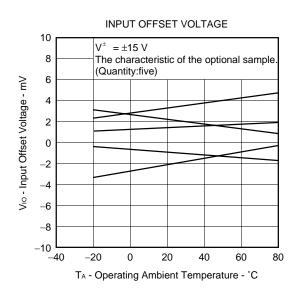
**★ 8.** This current flows irrespective of the existence of use.

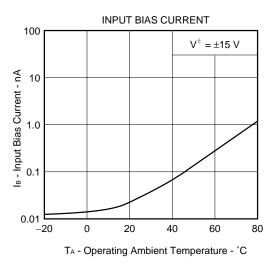
3

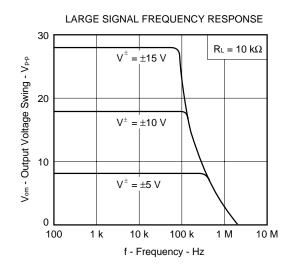
## TYPICAL PERFORMANCE CHARACTERISTICS (TA = 25°C, TYP.)

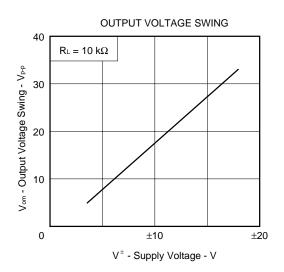




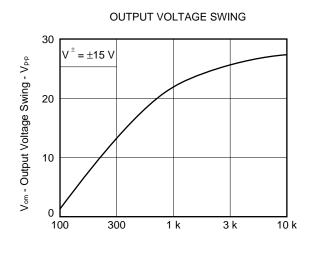


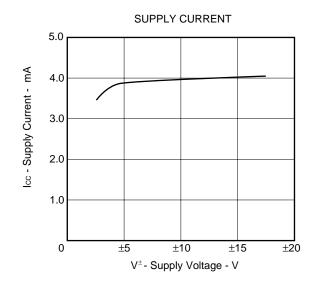




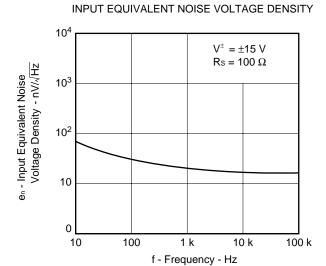


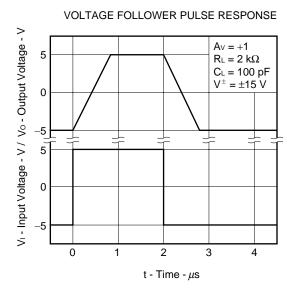
**NEC** μPC4082





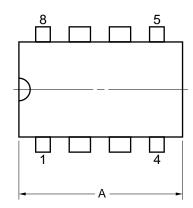
 $R_{\mathsf{L}}$  - Load Resistance -  $\!\Omega$ 

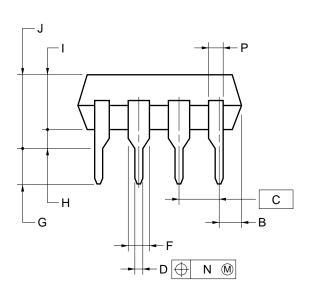


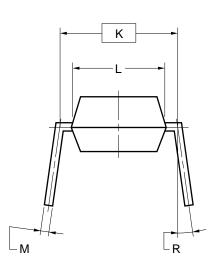


## PACKAGE DRAWINGS (Unit: mm)

# 8-PIN PLASTIC DIP (7.62mm(300))







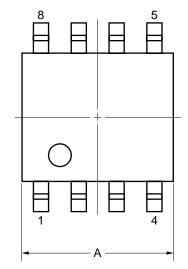
## NOTES

- 1. Each lead centerline is located within 0.25 mm of its true position (T.P.) at maximum material condition.
- 2. Item "K" to center of leads when formed parallel.

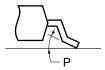
ITEM	MILLIMETERS
Α	10.16 MAX.
В	1.27 MAX.
С	2.54 (T.P.)
D	0.50±0.10
F	1.4 MIN.
G	3.2±0.3
Н	0.51 MIN.
I	4.31 MAX.
J	5.08 MAX.
K	7.62 (T.P.)
L	6.4
М	0.25 <sup>+0.10</sup> <sub>-0.05</sub>
N	0.25
P	0.9 MIN.
R	0~15°
	29C-100-200B C-2

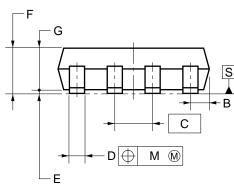
P8C-100-300B,C-2

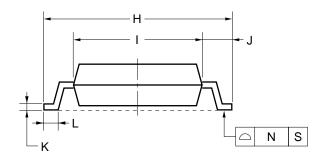
# 8-PIN PLASTIC SOP (5.72 mm (225))



detail of lead end







NOTE

Each lead centerline is located within 0.12 mm of its true position (T.P.) at maximum material condition.

MILLIMETERS
$5.2_{-0.20}^{+0.17}$
0.78 MAX.
1.27 (T.P.)
$0.42^{+0.08}_{-0.07}$
0.1±0.1
1.59±0.21
1.49
6.5±0.3
4.4±0.15
1.1±0.2
$0.17^{+0.08}_{-0.07}$
0.6±0.2
0.12
0.10
3°+7°

S8GM-50-225B-6

## \* RECOMMENDED SOLDERING CONDITIONS

The  $\mu$ PD4082 should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

### **Type of Surface Mount Device**

 $\mu$ PC4082G2: 8-pin plastic SOP (5.72 mm (225))

Process	Conditions	Symbol
Infrared Ray Reflow	Peak temperature: 230°C or below (Package surface temperature), Reflow time: 30 seconds or less (at 210°C or higher), Maximum number of reflow processes: 1 time.	IR30-00-1
Vapor Phase Soldering	Peak temperature: 215°C or below (Package surface temperature), Reflow time: 40 seconds or less (at 200°C or higher), Maximum number of reflow processes: 1 time.	VP15-00-1
Wave Soldering	Solder temperature: 260°C or below, Flow time: 10 seconds or less,  Maximum number of flow processes: 1 time,  Pre-heating temperature: 120°C or below (Package surface temperature).	WS60-00-1
Partial Heating Method	Pin temperature: 300°C or below, Heat time: 3 seconds or less (Per each side of the device).	-

Caution Apply only one kind of soldering condition to a device, except for "partial heating method", or the device will be damaged by heat stress.

## Type of Through-hole Device

μPC4082C: 8-pin plastic DIP (7.62 mm (300))

Process	Conditions	
Wave Soldering	older temperature: 260°C or below,	
(only to leads)	Flow time: 10 seconds or less.	
Partial Heating Method	Pin temperature: 300°C or below, Heat time: 3 seconds or less (per each lead).	

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

NEC  $\mu$ PC4082

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430232AB LM2904DR2GH LM358YDT LT1678IS8 042225DB 058184EB 070530X SC224DR2G SC239DR2G SC2902DG

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